

High and Low Side Driver

Features

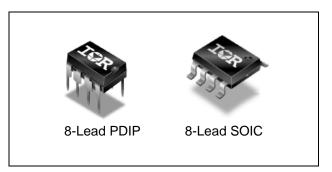
- Floating channel designed for bootstrap operation
- Fully operational to 200V
- Tolerant to negative transient voltage, dV/dt immune
- Gate drive supply range from 10 to 20V
- Independent low and high side channels
- Input logic HIN/LIN active high
- Undervoltage lockout for both channels
- 3.3V and 5V logic compatible
- CMOS Schmitt-triggered inputs with pull-down
- Matched propagation delay for both channels

Product Summary

V _{OFFSET} (max)	200V
I _{O+/-} (typ)	1.0A / 1.0A
V _{OUT}	10 – 20V
t _{on/off} (typ)	80ns & 60ns
Delay Matching (max)	20ns

Description

The IR2011 is a high power, high speed power MOSFET driver with independent high and low side referenced output Package Options channels. Logic inputs are compatible with standard CMOS or LSTTL output, down to 3.0V logic. The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. Propagation delays are matched to simplify use in high frequency applications. The floating channel can be used to drive an N-channel power MOSFET in the high side configuration which operates up to 200 volts. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction.



Applications

- Converters
- DC motor drive

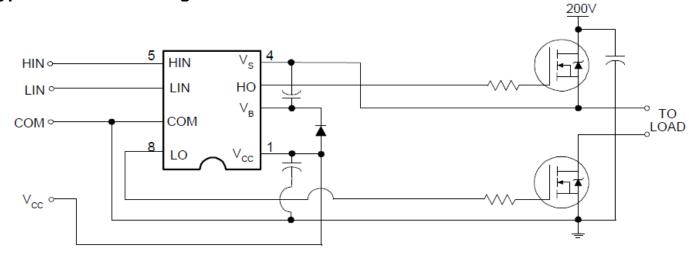
Ordering Information

Danie Bart Namelan		Standar	d Pack	On to sell a Don't Novel and
Base Part Number	Package Type	Form	Quantity	Orderable Part Number
IR2011PBF	PDIP8	Tube	50	IR2011PBF
IR2011SPBF	SO8N	Tube	95	IR2011SPBF
IR2011SPBF	SO8N	Tape and Reel	2500	IR2011STRPBF



Typical Connection Diagram

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(Refer to Lead Assignments for correct configuration.) This diagram shows electrical connections only. Please refer to our Application Notes and Design Tips for proper circuit board layout



Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition	Min.	Max.	Units	
V_{B}	High side floating supply voltage		-0.3	225	
V_S	High side floating supply offset volta	ige	V _B - 25	$V_B + 0.3$	
V_{HO}	High side floating output voltage		V _S - 0.3	V _B + 0.3	V
V _{cc}	Low side fixed supply voltage		-0.3	25]
V_{LO}	Low side output voltage		-0.3	V _{CC} + 0.3	
V _{IN}	Logic input voltage (HIN, LIN)		-0.3	V _{CC} + 0.3	
dV _s /dt	Allowable offset supply voltage trans	sient	_	50	V/ns
Б	Package power dissipation	8-Lead PDIP	_	1.0	10/
P_D	$@ T_A \le +25^{\circ}C$ 8-Lead SC	8-Lead SOIC	_	0.625	W
Dul	Thermal resistance, junction to	8-Lead PDIP	_	125	0000
Rtn _{JA}	Rth _{JA} ambient		_	200	°C/W
TJ	Junction temperature	_	150		
T _S	Storage temperature		-55	150	°C
TL	Lead temperature (soldering, 10 sec	conds)	_	300	

Recommended Operating Conditions

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For proper operation the device should be used within the recommended conditions. The V_S and COM offset ratings are tested with all supplies biased at 15V differential.

Symbol	Definition	Min.	Max.	Units
V_B	High side floating supply absolute voltage	V _S + 10	V _S + 20	
V_S	High side floating supply offset voltage	†	200	
V_{HO}	High side floating output voltage	Vs	V _B	V
V_{CC}	Low side fixed supply voltage	10	20]
V_{LO}	Low side output voltage	0	V _{CC}	
V_{IN}	Logic input voltage (HIN, LIN)	COM	5.5	
T _A	Ambient temperature	-40	125	°C

 $^{^{+}}$ Logic operational for V_S of -4 to +200V. Logic state held for V_S of -4V to -V_{BS}.



Dynamic Electrical Characteristics

 V_{BIAS} (V_{CC} , V_{BS}) = 15V, C_L = 1000pF and T_A = 25°C unless otherwise specified. Figure 1 shows the timing definitions.

Symbol	Definition	Min.	Тур.	Max.	Units	Test Conditions
t _{on}	Turn-on propagation delay		80	_		V _S = 0V
t _{off}	Turn-off propagation delay	_	75	_		V _S = 200V
t _r	Turn-on rise time		35	50		
t _f	Turn-off fall time	_	20	35	ns	
DM1	Turn-on delay matching t _{on} (H) - t _{on} (L)	_	_	20		
DM2	Turn-off delay matching t _{off} (H) - t _{off} (L)	_	_	20		

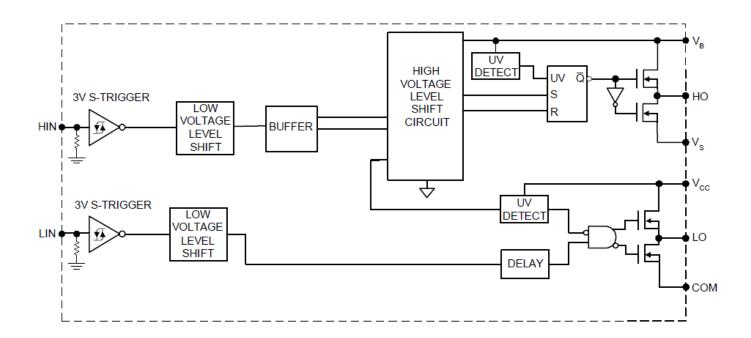
Static Electrical Characteristics

 V_{BIAS} (V_{CC} , V_{BS}) = 15V and T_A = 25°C unless otherwise specified. The V_{IN} , V_{TH} and I_{IN} parameters are referenced to COM and are applicable to all logic input leads: HIN and LIN. The V_O and I_O parameters are referenced to COM and are applicable to the respective output leads: HO or LO.

Symbol	Definition	Min.	Тур.	Max.	Units	Test Conditions
V _{IH}	Logic "1" input voltage	2.2	_			$V_{CC} = 10V - 20V$
V_{IL}	Logic "0" input voltage	_	_	0.7	V	V _{CC} = 10V - 20V
V_{OH}	High level output voltage, V _{BIAS} - V _O	_	_	2.0	_ v	$I_{O} = 0A$
V_{OL}	Low level output voltage, V _O			0.2		$I_O = 20mA$
I_{LK}	Offset supply leakage current			50		$V_{B} = V_{S} = 200V$
I_{QBS}	Quiescent V _{BS} supply current		90	210		$V_{IN} = 0V \text{ or } 3.3V$
I _{QCC}	Quiescent V _{CC} supply current	_	140	230	μA	V _{IN} = 0 V 0I 3.3 V
I _{IN+}	Logic "1" input bias current	_	7.0	20		$V_{IN} = 3.3V$
I _{IN-}	Logic "0" input bias current	_	_	1.0		$V_{IN} = 0V$
V _{BSUV+}	V _{BS} supply undervoltage positive going threshold	8.2	9.0	9.8		
V _{BSUV} -	V _{BS} supply undervoltage negative going threshold	7.4	8.2	9.0	\ \ <u>\</u>	
V _{CCUV+}	V _{CC} supply undervoltage positive going threshold	8.2	9.0	9.8	V	
V _{CCUV-}	V _{CC} supply undervoltage negative going threshold	7.4	8.2	9.0		
I _{O+}	Output high short circuit pulsed current	_	1.0	_	^	V _O = 0V, PW ≤ 10 μs
I _{O-}	Output low short circuit pulsed current	_	1.0	_	A	V _O = 15V PW ≤ 10 μs



Functional Block Diagram

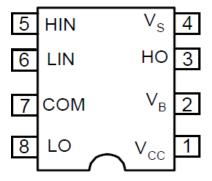


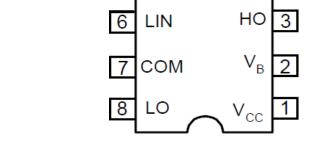


Lead Definitions

Symbol	Description	
HIN	Logic input for high side gate driver outputs (HO), in phase	
LIN	Logic input for low side gate driver outputs (LO), in phase	
V_B	High side floating supply	
НО	High side gate drive output	
Vs	High side floating supply return	
V _{CC}	Low side supply	
LO	Low side gate drive output	
COM	Low side return	

Lead Assignments





HIN

8-Lead PDIP

8-Lead SOIC



Application Information and Additional Details

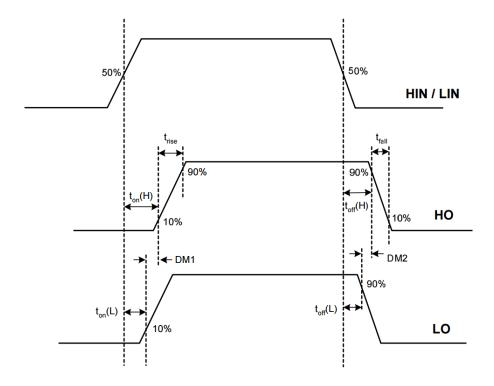
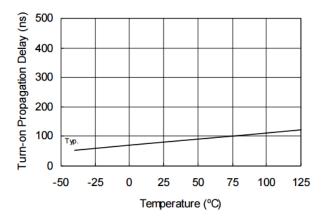


Figure 1. Timing Diagram





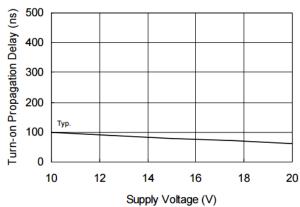
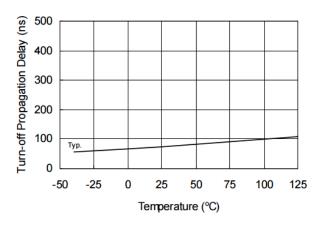


Figure 2A. Turn-on Propagation Delay vs. Temperature

Figure 2B. Turn-on Propagation Delay vs. Supply Voltage



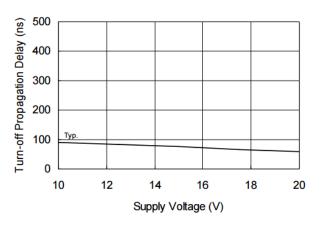
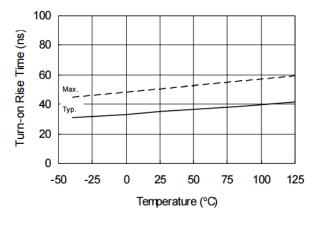


Figure 3A. Turn-off Propagation Delay vs. Temperature

Figure 3B. Turn-off Propagation Delay vs. Supply Voltage



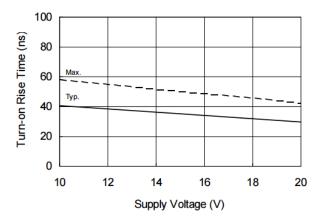
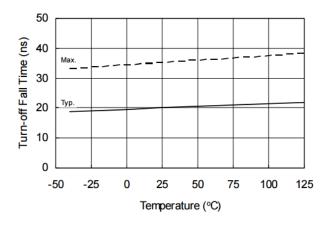


Figure 4A. Turn-on Rise Time vs. Temperature

Figure 4B. Turn-on Rise Time vs. Supply Voltage





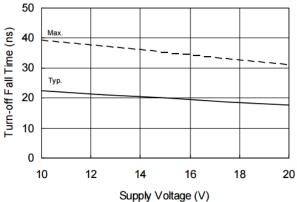
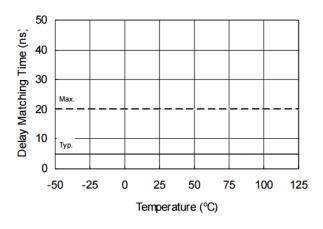


Figure 5A. Turn-off Fall Time vs. Temperature

Figure 5B. Turn-off Fall Time vs. Supply Voltage



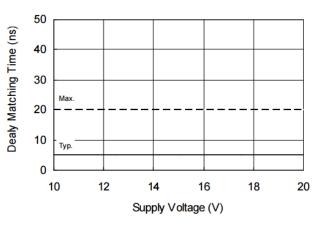
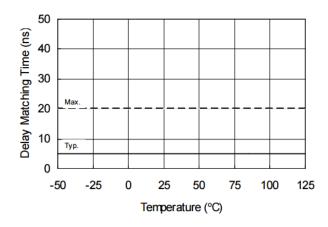


Figure 6A. Turn-on Delay Matching vs. Temperature

Figure 6B. Turn-on Delay Matching Time vs. Supply Voltage



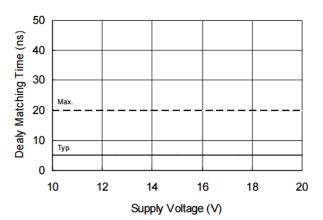
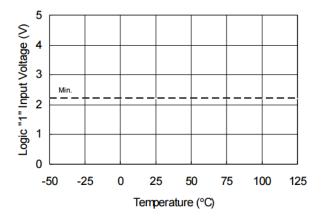


Figure 7A. Turn-off Delay Matching Time vs. Temperature

Figure 7B. Turn-off Delay Matching Time vs. Supply Voltage





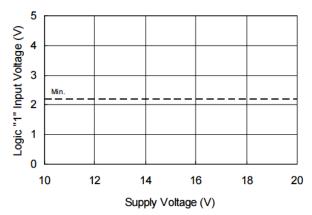
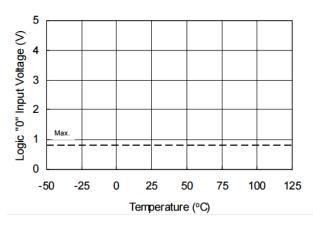


Figure 8A. Logic "1" Input Voltage vs. Temperature

Figure 8B. Logic "1" Input Voltage vs. Supply Voltage



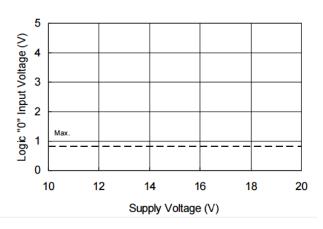


Figure 9A. Logic "0" Input Voltage vs. Temperature

Figure 9B. Logic "0" Input Voltage vs. Supply Voltage

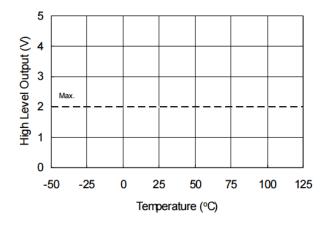
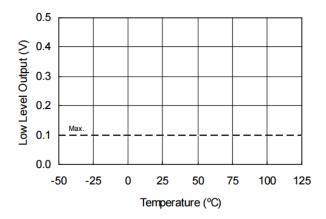




Figure 10A. High Level Output vs. Temperature

Figure 10B. High Level Output vs. Supply Voltage





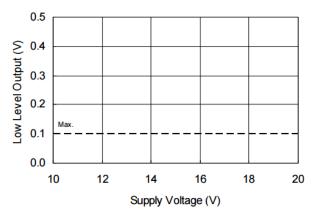


Figure 11A. Low Level Output vs. Temperature

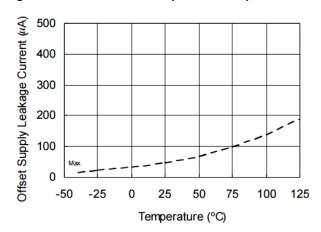


Figure 11B. Low Level Output vs. Supply Voltage

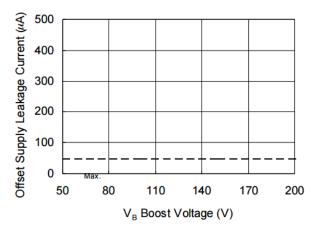


Figure 12A. Offset Supply Leakage Current vs.
Temperature

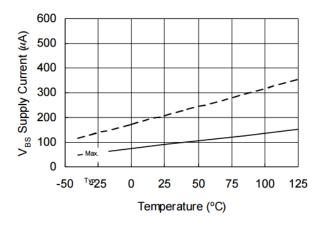


Figure 12B. Offset Supply Leakage Current vs. Supply Voltage

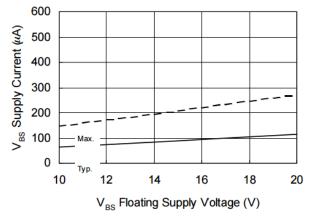
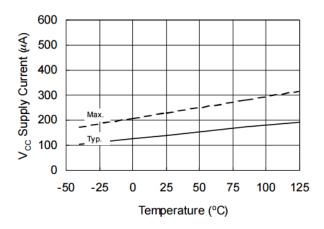


Figure 13A. V_{BS} Supply Current vs. Temperature

Figure 13B. V_{BS} Supply Current vs. Supply Voltage

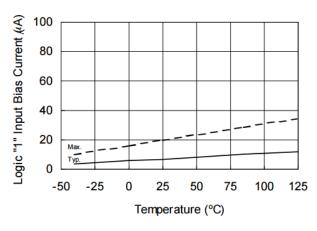




600 V_{cc} Supply Current (MA) **500** 400 300 200 100 Тур 0 10 12 14 16 18 20 V_{CC} Supply Voltage (V)

Figure 14A. V_{CC} Supply Current vs. Temperature

Figure 14B. V_{CC} Supply Current vs. V_{CC} Supply Voltage



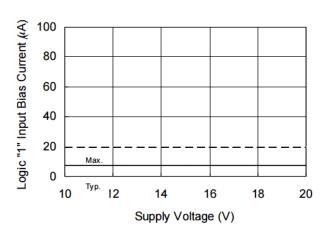
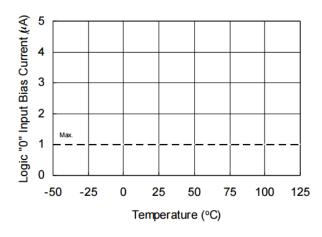


Figure 15A. Logic "1" Input Bias Current vs. Temperature

Figure 15 B. Logic "1" Input Bias Current vs. Supply Voltage



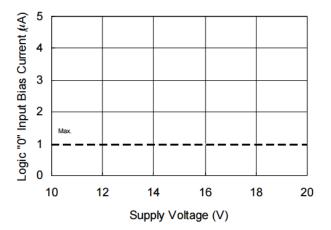


Figure 16A. Logic "0" Input Bias Current vs.
Temperature

Figure 16B. Logic "0" Input Bias Current vs. Supply Voltage



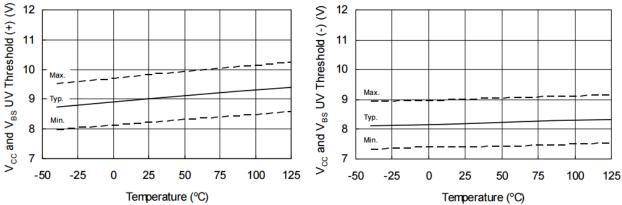
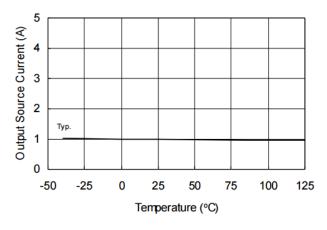


Figure 17. V_{CC} and V_{BS} Undervoltage Threshold (+) vs. Temperature

Figure 18. V_{CC} and V_{BS} Undervoltage Threshold (-) vs. Temperature



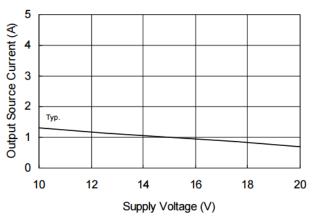
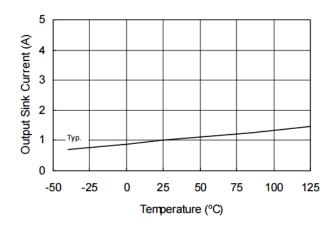


Figure 19A. Output Source Current vs. Temperature

Figure 19B. Output Source Current vs. Supply Voltage



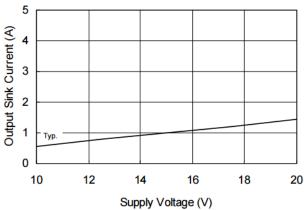


Figure 20A. Output Sink Current vs. Temperature

Figure 20B. Output Sink Currnt vs. Supply Voltage



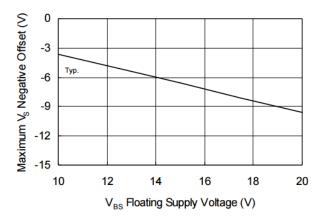
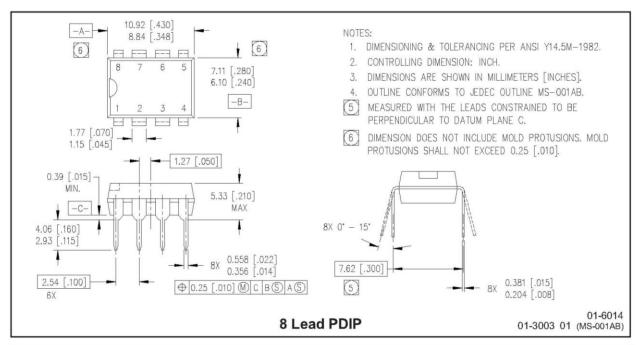
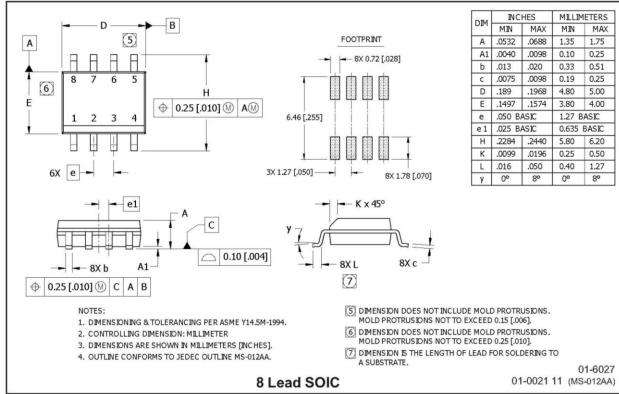


Figure 21. Maximum V_S Negative Offset vs. V_{BS} Floating Supply Voltage



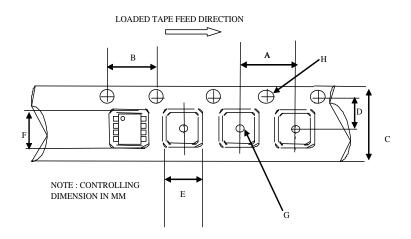
Package Details





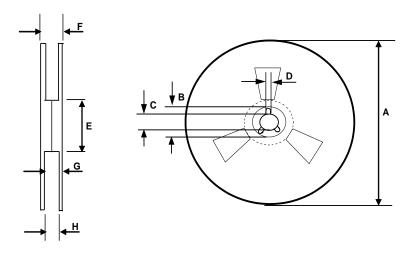


Tape and Reel Details



CARRIER TAPE DIMENSION FOR 8SOICN

	Me	tric	Imp	erial	
Code	Min	Max	Min	Max	
A	7.90	8.10	0.311	0.318	
В	3.90	4.10	0.153	0.161	
С	11.70	12.30	0.46	0.484	
D	5.45	5.55	0.214	0.218	
E	6.30	6.50	0.248	0.255	
F	5.10	5.30	0.200	0.208	
G	1.50	n/a	0.059	n/a	
Н	1.50	1.60	0.059	0.062	

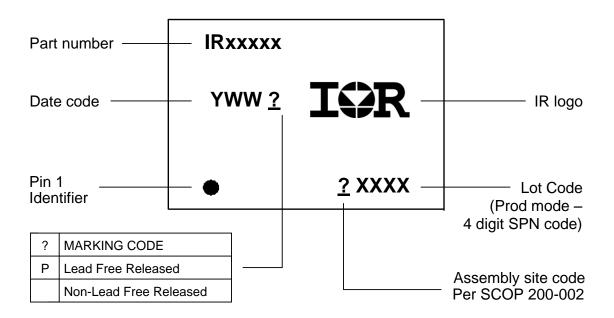


REEL DIMENSIONS FOR 8SOICN

	Me	tric	Imp	erial
Code	Min	Max	Min	Max
Α	329.60	330.25	12.976	13.001
В	20.95	21.45	0.824	0.844
С	12.80	13.20	0.503	0.519
D	1.95	2.45	0.767	0.096
E	98.00	102.00	3.858	4.015
F	n/a	18.40	n/a	0.724
G	14.50	17.10	0.570	0.673
Н	12.40	14.40	0.488	0.566



Part Marking Information





Qualification Information[†]

Qualification informatio	••	
Qualification Level		Industrial ^{††} (per JEDEC JESD 47)
		Comments: This family of ICs has passed JEDEC's Industrial qualification. IR's Consumer qualification level is
		granted by extension of the higher Industrial level.
Moisture Sensitivity Level	8-Lead SOIC	MSL2 ^{†††} (per IPC/JEDEC J-STD-020)
RoHS Compliant		Yes

- † Qualification standards can be found at International Rectifier's web site http://www.irf.com/
- †† Higher qualification ratings may be available should the user have such requirements. Please contact your International Rectifier sales representative for further information.
- ††† Higher MSL ratings may be available for the specific package types listed here. Please contact your International Rectifier sales representative for further information.

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